

**STATEMENT UNDER 37 CFR 3.73(b)**

Applicant/Patent Owner: Joseph C. Fjelstad et al.

Application No./Patent No.: 6,891,272

Filed/Issue Date: 05-10-2005

Titled:

**MULTI-PATH VIA INTERCONNECTION STRUCTURES AND METHODS FOR MANUFACTURING THE SAME**

Samsung Electronics Co., Ltd.

, a Corporation

(Name of Assignee)

(Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)

states that it is:

1. ☒ the assignee of the entire right, title, and interest in;
  2. ☐ an assignee of less than the entire right, title, and interest in  
(The extent (by percentage) of its ownership interest is \_\_\_\_\_ %); or
  3. ☐ the assignee of an undivided interest in the entirety of (a complete assignment from one of the joint inventors was made)
- the patent application/patent identified above, by virtue of either:

A. ☐ An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy therefore is attached.

OR

B. ☒ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as follows:

1. From: Fjelstad et al.

To: Silicon Pipe, Inc.

The document was recorded in the United States Patent and Trademark Office at

Reel 014403, Frame 0609, or for which a copy thereof is attached.

2. From: Silicon Pipe, Inc.

To: Secure Note Holders: Anderson et al.

The document was recorded in the United States Patent and Trademark Office at

Reel 021380, Frame 0276, or for which a copy thereof is attached.

3. From: Secure Note Holders: Anderson et al.

To: Novias, LLC

The document was recorded in the United States Patent and Trademark Office at

Reel 021744, Frame 0512, or for which a copy thereof is attached.

☒ Additional documents in the chain of title are listed on a supplemental sheet(s).

☐ As required by 37 CFR 3.73(b)(1)(i), the documentary evidence of the chain of title from the original owner to the assignee was, or concurrently is being, submitted for recordation pursuant to 37 CFR 3.11.

[NOTE: A separate copy (i.e., a true copy of the original assignment document(s)) must be submitted to Assignment Division in accordance with 37 CFR Part 3, to record the assignment in the records of the USPTO. See MPEP 302.08]

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

Signature

Robert N. Crouse

Printed or Typed Name

November 11, 2010

Date

Attorney of Record

Title

This collection of information is required by 37 CFR 3.73(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

**Chain of Title (Cont.)  
Statement Under 37 CFR 3.73(b)**

A chain of title from the inventor(s), of the patent application/patent identified previously, to the current assignee as follows:

2. From: Novias, LLC To: Interconnect Portfolio, LLC

The document was recorded in the United States Patent and Trademark Office at

Reel 021861, Frame 0127, or for which a copy thereof is attached.

3. From: Interconnect Portfolio, LLC To: Technology Properties Limited LLC

The document was recorded in the United States Patent and Trademark Office at

Reel 022343, Frame 0351, or for which a copy thereof is attached.

4. From: Technology Properties Limited To: Samsung Electronics Co., Ltd.

The document was recorded in the United States Patent and Trademark Office at

Reel 025105, Frame 0596, or for which a copy thereof is attached.

5. From: Interconnect Portfolio, LLC, Intellasis BEC Limited, Technology Properties Limited  
To: Samsung Electronics Co., Ltd.

The document was recorded in the United States Patent and Trademark Office at

Reel 025105, Frame 0634, or for which a copy thereof is attached.